

Low Loss IGBT : IGBT in TRENCHSTOP™ and Fieldstop technology











Features:

- Very low V_{CE(sat)} 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
- Designed for :
 - Frequency Converters
 - Uninterrupted Power Supply
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
 - low V_{CE(sat)}
- Positive temperature coefficient in V_{CE(sat)}
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

Туре	V _{CE}	I _C	V _{CE(sat),Tj=25℃}	T _{j,max}	Marking	Package
IGW50N60T	600 V	50 A	1.5 V	175 °C	G50T60	PG-TO247-3

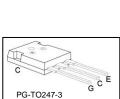
Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V _{CE}	600	V
DC collector current, limited by T _{jmax}			
$T_{\rm C}$ = 25°C, value limited by bondwire	I _C	90	
$T_{\rm C} = 100^{\circ}{\rm C}$		64	A
Pulsed collector current, t_p limited by T_{jmax}	<i>I</i> _{Cpuls}	150	
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^{\circ}C$, $t_p = 1\mu s$	-	150	
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time ²⁾	1	5	
$V_{\rm GE}$ = 15V, $V_{\rm CC} \le 400$ V, $T_{\rm j} \le 150^{\circ}$ C	t _{sc}	5	μs
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	333	W
Operating junction temperature	T _j	-40+175	
Storage temperature	T _{stg}	-55+150	°C
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.







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Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	$R_{ m thJC}$		0.45	K/W
junction – case				
Thermal resistance,	R _{thJA}		40	
junction – ambient				

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Deremeter	Sumbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	Тур.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_{C}=0.2mA$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 V, I_{\rm C} = 50 A$				
		<i>T</i> _j =25°C	-	1.5	2.0	
		<i>T</i> _j =175°C	-	1.9	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C}=0.8$ mA, $V_{\rm CE}=V_{\rm GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μA
		T _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	3500	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE} = 0 \rm V, V_{\rm GE} = 20 \rm V$	-	-	100	nA
Transconductance	$g_{ m fs}$	$V_{\rm CE} = 20 V, I_{\rm C} = 50 A$	-	31	-	S
Integrated gate resistor	R _{Gint}			-	•	Ω

Dynamic Characteristic

Input capacitance	Ciss	V _{CE} =25V,	-	3140	-	pF
Output capacitance	Coss	$V_{\rm GE}=0V$,	-	200	-	
Reverse transfer capacitance	Crss	f=1MHz	-	93	-	
Gate charge	Q _{Gate}	$V_{\rm CC}$ =480V, $I_{\rm C}$ =50A	-	310	-	nC
		$V_{GE}=15V$				
Internal emitter inductance	L _E	PG-TO-220-3-1	-	7	-	nH
measured 5mm (0.197 in.) from case		PG-TO-247-3-21	-	13	-	
Short circuit collector current ¹⁾	I _{C(SC)}	$V_{GE} = 15V, t_{SC} \le 5\mu s$ $V_{CC} = 400V,$ $T_j \le 150^{\circ}C$	-	458.3	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at $T_j=25 \text{ °C}$

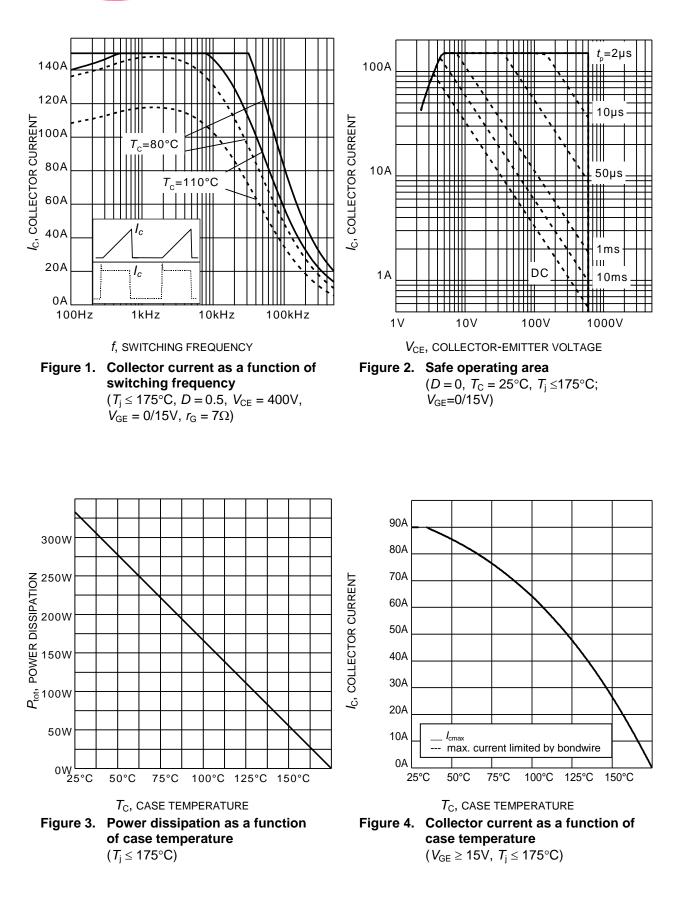
Parameter	Symbol	Conditions	Value			Unit
Parameter			min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_{\rm j}=25^{\circ}{\rm C},$	-	26	-	ns
Rise time	tr	$V_{CC} = 400V, I_C = 50A, V_{GE} = 0/15V, r_G = 7\Omega, L_{\sigma} = 103nH, C_{\sigma} = 39pF L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery. Diode from IKW50N60T	-	29	-	1
Turn-off delay time	$t_{d(off)}$		-	299	-]
Fall time	t _f		-	29	-	1
Turn-on energy	Eon		-	1.2	-	mJ
Turn-off energy	E _{off}		-	1.4	-	7
Total switching energy	E _{ts}		-	2.6	-]

Switching Characteristic, Inductive Load, at T_j =150 °C

Parameter	Symbol	Conditions	Value			11
			min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	$T_{j}=175^{\circ}C,$ $V_{CC}=400V, I_{C}=50A,$ $V_{GE}=0/15V, r_{G}=7\Omega,$ $L_{\sigma}=103nH, C_{\sigma}=39pF$ L_{σ}, C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery. Diode from IKW50N60T	-	27	-	ns
Rise time	t _r		-	33	-	
Turn-off delay time	$t_{d(off)}$		-	341	-	
Fall time	t _f		-	55	-	
Turn-on energy	Eon		-	1.8	-	mJ
Turn-off energy	E _{off}		-	1.8	-	
Total switching energy	Ets		-	3.6	-	



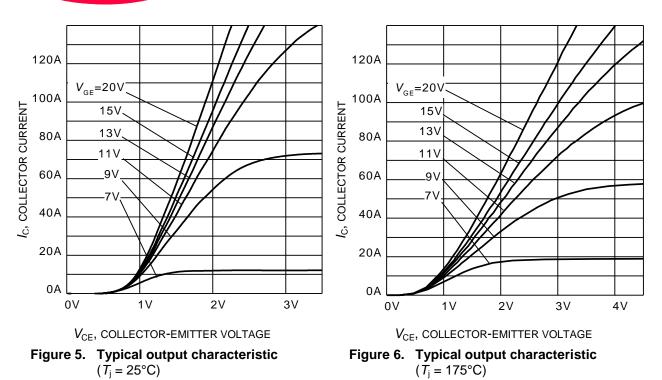
TRENCHSTOP™ Series

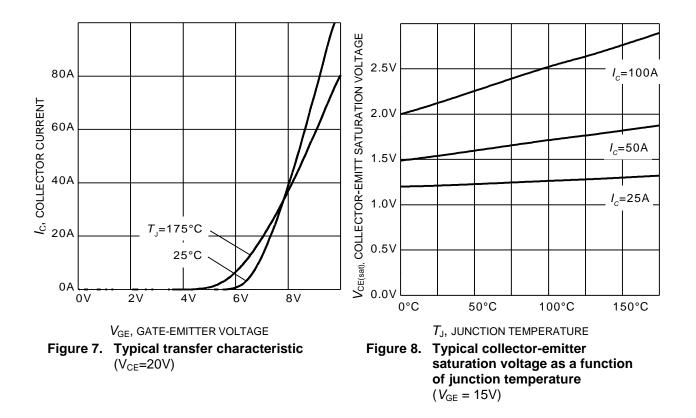




TRENCHSTOP™ Series

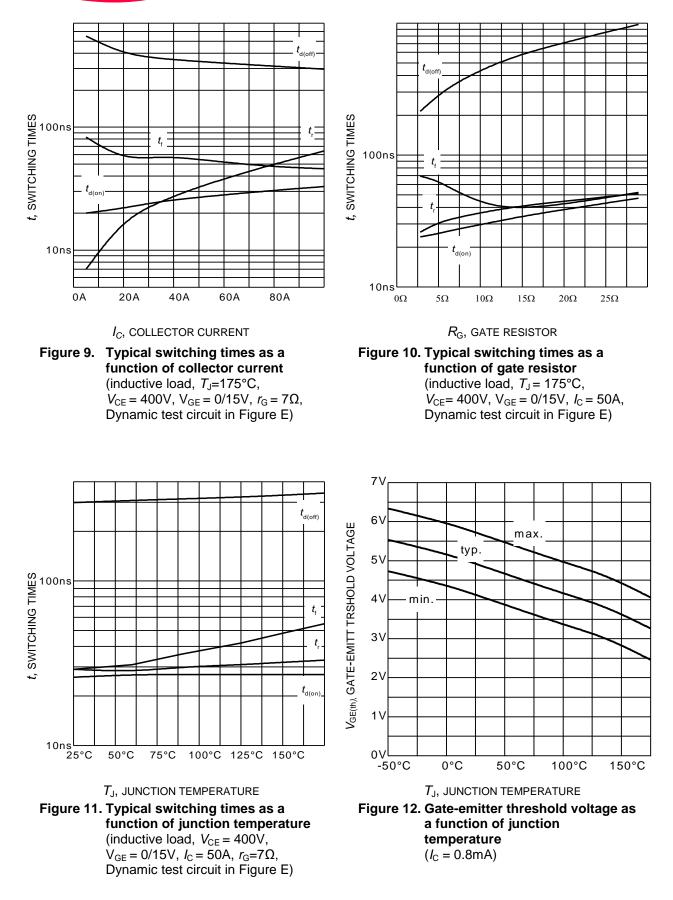
IGW50N60T







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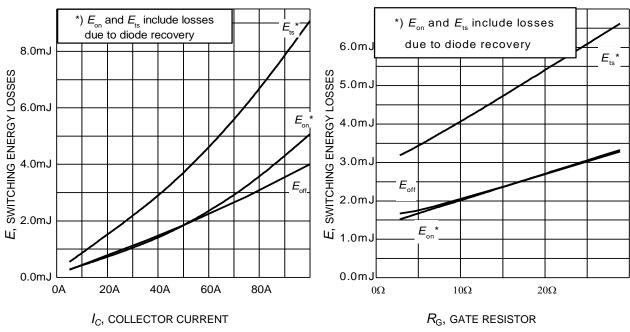
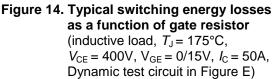
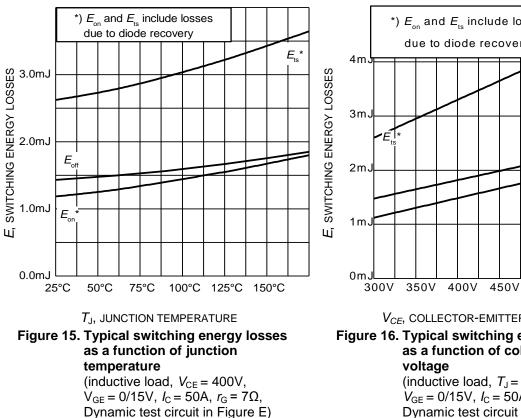


Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_J = 175^{\circ}C$, $V_{\rm CE} = 400$ V, $V_{\rm GE} = 0/15$ V, $r_{\rm G} = 7\Omega$, Dynamic test circuit in Figure E)





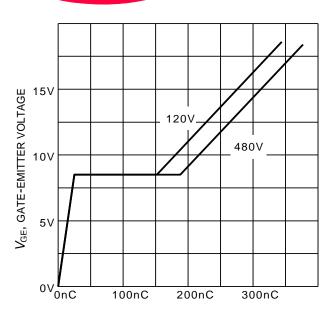
*) E_{on} and E_{ts} include losses due to diode recovery F $E_{\rm off}$ 500V 550V

 V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 16. Typical switching energy losses as a function of collector emitter (inductive load, $T_J = 175^{\circ}$ C,

 $V_{\rm GE} = 0/15 \text{V}, I_{\rm C} = 50 \text{A}, r_{\rm G} = 7 \Omega,$ Dynamic test circuit in Figure E)



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 Q_{GE} , GATE CHARGE Figure 17. Typical gate charge $(I_C=50 \text{ A})$

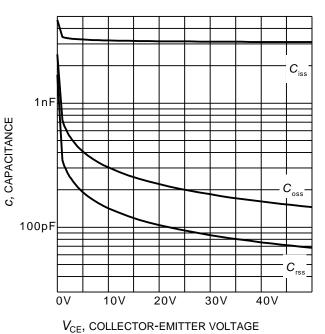
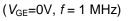
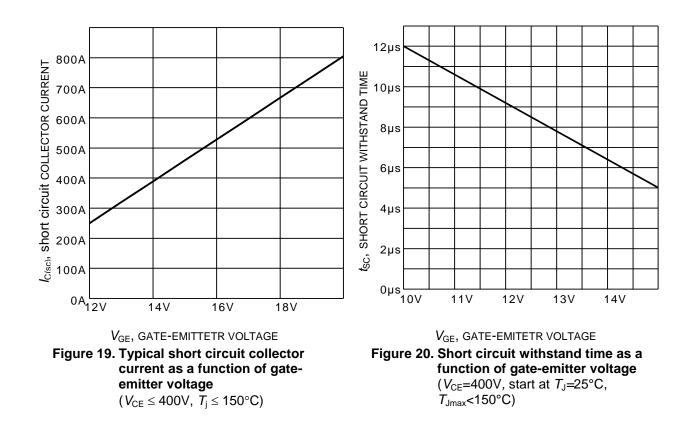
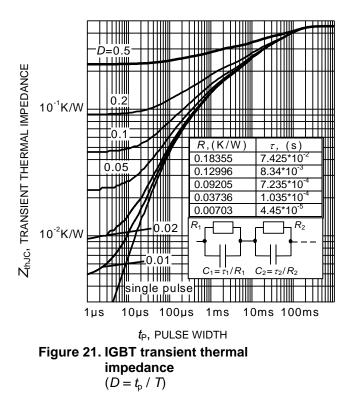


Figure 18. Typical capacitance as a function of collector-emitter voltage





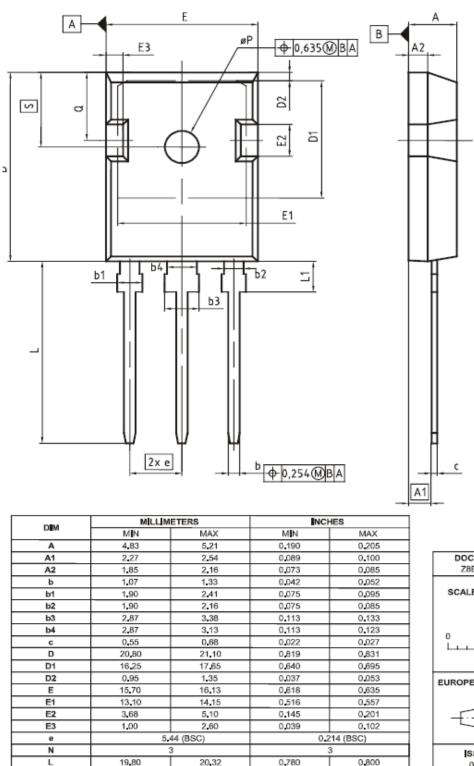






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PG-TO247-3



4.47

3.70

6.00

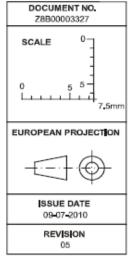
6,30

4.10

3.50

5,49

6.04



IGW50N60T

L1

øP

Q

s

0,176

0.146

0,236

0.248

0.161

0.138

0,216

0.238



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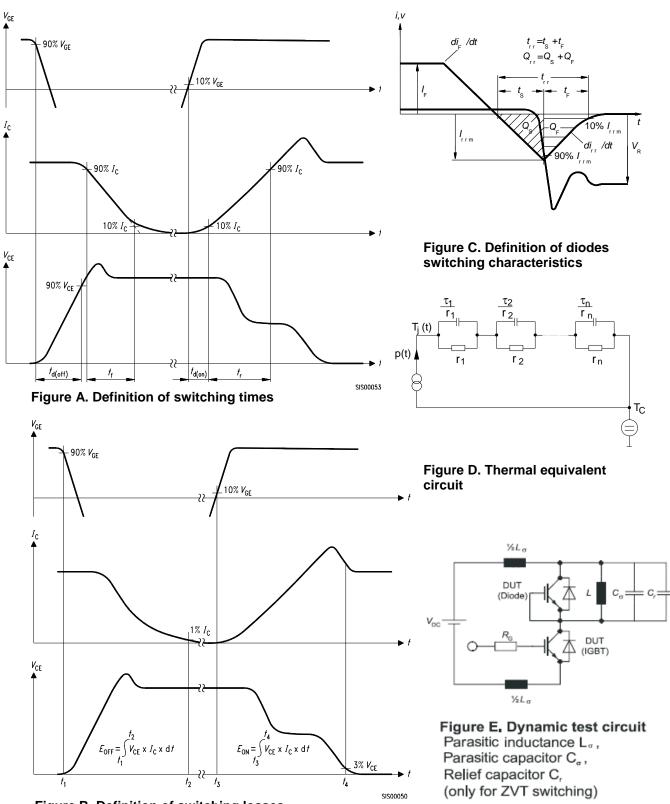


Figure B. Definition of switching losses



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